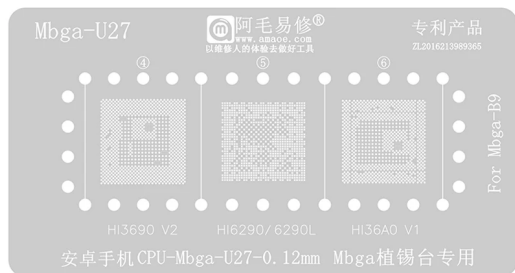


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AMAOE BGA Mbga-U27 stencil reballing BGA CPU HI3690v2 HI6290/6290L HI36A0v 0,12mm for MBGA-B9

Product ID: 23009

Price: **7.00 EUR**

Product weight: **0.20 kg**

Description:

AMAOE BGA Mbga-U27 stencil reballing BGA CPU HI3690v2 HI6290/6290L HI36A0v 0,12mm for MBGA-B9- the sieves are a product made of steel resistant to high temperatures and deformations. Precise laser-cut templates facilitate positioning during work.

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